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HD63B09E, HD63C09E CMOS MPU (Micro Processing Unit)

The HD6309E is the highest 8-bit microprocessor of HMCS6800 family, which is just compatible with the conventional HD6809E.

The HD6309E has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications. External clock inputs are provided to allow synchronization with peripherals, systems or other MPUs.

The HD6309E is complete CMOS device and the power dissipation is extremely low. Moreover, the SYNC and CWAI instruction makes low power application possible.

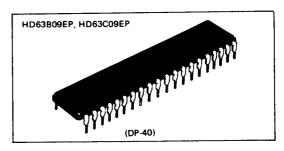
- **FEATURES**
- Hardware Interface with All HMCS6800 Peripherals
- Software Object Code Compatible with the HD6809E
- Low Power Consumption Mode (Sleep mode)

SYNC state of SYNC Instruction WAIT state of CWAI Instruction

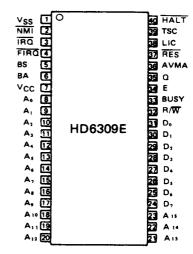
- External Clock Inputs, E and Q, Allow Synchronization
- Wide Operation Range

f = 0.5 to 3MHz ($V_{CC}=5V\pm10\%$)

Type No.	Bus Timing
HD63B09E	2.0MHz
HD63C09E	3.0MHz



PIN ARRANGEMENT



(Top View)

BABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	v _{cc} •	-0.3 ~ +7.0	V
Input Voltage	V _{in} *	-0.3 ~ +7.0	V
Maximum Output Current	101**	5	mA
Maximum Total Output Current	ΣΙο ***	100	mA
Operating Temperature	Topr	-20 ~ +75	°c
Storage Temperature	T _{stg}	-55 ~ +150	°C

^{*} With respect to V_{SS} (SYSTEM GND)

■ RECOMMENDED OPERATING CONDITIONS

Item		Symbol	min	typ	max	Unit
Suppl	y Voltage	Vcc*	4.5	5.0	5.5	٧
	Logic, RES	V _{IL} *	-0.3	_	0.8	V
	E, Q	VILC*	-0.3	-	0.4	٧
nput Voltage	Logic		2.0	_	Vcc	٧
	E, Q	V _{IH} *	3.0	_	Vcc	V
	RES		V _{CC} 0.5	_	Vcc	٧
Operating Temperature		Topr	-20	25	75	°c

^{*} With respect to VSS (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC_CHARACTERISTICS (V_{CC}=5.0V±10%, V_{SS}=0V, T₂=- 20 ~ +75°C, unless otherwise noted.)

Item		Symbol	Test Condition	Н	D63B09E		H H	D63C09E		Unit
ITem		Symbol	1 est Condition	min	typ*	max	min	typ*	max	Unit
	Logic	VIH		2.0	-	Vcc.	2.0	_	Vcc	>
Input "High" Voltage	E, Q	VΙΗ		3.0	_	Vcc	3.0	-	Vcc	~
	RES	VIHR		V _{CC} -0.5	_	Vcc	V _{CC} -0.5	-	Vcc	>
Input "Low" Voltage	Logic, RES	^ آ		-0.3	_	0.8	-0.3	_	0.8	~
Import Cont Voltage	E, Q	VILC		- b.3	_	0.4	~0.3	_	0.4	~
Input Leakage Current	Logic, Q, RES	1.	V _{in} =0 ~ V _{CC,} \	-2.5		2.5	-2.5	-	2.5	μА
Imput Leakage Current	E	lin	V _{CC} =max	-10	_	10	-10		10	μА
	Da ~ D,		ILOAD=400μA	4.1		-	4,1	_	_	
	D ₀ ~ D ₇	}	ILOAD≦-10µA	Vcc-0.1	_		V _{CC} -0.1	_	-	V
Output "High" Voltage	A. ~ A., R/W	اا	ILOAD=400µA	4.1		_	4.1	_		.,
-	A6 ~ AB, H/W	Voн	ILOAD≦-10µA	V _{CC} -0.1	_	_	V _{CC} -0.1	-	- 1	v
	BA, BS, LIC,]	LOAD=-400µA	4.1			4.1	_		>
	AVMA, BUSY		ILOAD≦-10µA	V _{CC} -0.1	-	-	V _{CC} -0.1	_	_	
Output "Low" Voltage		VOL	ILOAD=2mA	-	-	0.5	-	-	0.5	>
Input Capacitance	Do ~D1, Logic Input Q, RES	Cin	V _{in} =0V, Te=25°C,	-	10	15	-	10	15	pF
	E]	f=1MHz		30	50	-	30	50	ρF
Output Capacitance	A _s ~A _s , R/W, BA, BS, LIC, AVMA, BUSY	Cout	V _{in} =0V, Ta=25°C, f=1MHz	_	10	15	-	10	15	pF
Frequency of Operation	E, Q	f		0.5	_	2.0	0.5		3.0	MHz
Three-State (Off State)	D ₀ ~ D ₇	I	Vin=0.4~VCC	-10	_	10	-10	-	10	μΑ
Input Current	A ₀ ~A ₁₅ , R/W	ITSI	VCC=max	-10	-	10	-10	-	10	μΑ
Current Dissipation		lcc	Operating	T T	_	20	- 1	_	30	
Current Dissipation		"	Sleeping	_	-	10	- 1	_	15	mA

^{*}Ta=25° C, V_{CC}=5V



^{**} Maximum output current is the maximum currents which can flow out from one output terminal and I/O common terminal.

⁽Ao ~ Ais, R/W, Do ~ Di, BA, BS, LIC, AVMA, BUSY)

^{***} Maximum total output current is the total sum of output currents which can flow out simultaneously from output terminals and I/O common terminals. (A₀ ~ A₁₅, R/W, D₀ ~ D₇, BA, BS, LIC, AVMA, BUSY)

⁽NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

ullet AC CHARACTERISTICS (V_{CC}=5.0V±10%, V_{SS}=0, Ta=-20 \sim +75 $^{\circ}$ C, unless otherwise noted.)

1. CLOCK TIMING

				1D63B09	E		HD63C09	E	Unit	
Item	Symbol Test Condition		min typ max		max	min	typ	max		
Cycle Time	tcyc		500	-	2000	333		2000	ns	
E Clock "Low"	tPWEL	Fig. 1,2	210	-	1000	140		1000	ns	
E Clock "High" (Measured at VIH)	tpWEH ter, tef tpWQH tor, tof		220	_	1000	140		1000	ns	
E Rise and Fall Time				_	20	_	_	15	ns	
Q Clock "High"			220	-	1000	140	_	1000	ns	
Q Rise and Fall Time			_		20	-		15	ns	
E "Low" to Q Rising E "Low"→Q"High"	tEQ1	1	100	-	-	65	-		ns	
Q "High" to E Rising Q "High"→E "High"	tEQ2		100	_	-	65			ns	
E "High" to Q Falling E "High"→Q"Low"	tEQ3		100	-	_	65	-		ns	
Q "Low" to E Falling Q "Low"→E "Low"	¹EQ4	1	100	_	-	65	-	-	ns	

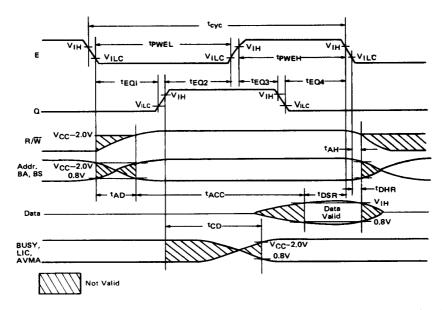
2. BUS TIMING

				H	ID63B09E		н	D63C09E		Unit	
Item Address Delay		Symbol Test Condition		min typ		max	min	typ	max]	
		tAD				110	1		110	ns	
Address Hold Time	Ta = 0 ~ 75°C			20	-		20			ns	
(Address, R/W, BA, BS)	Ta = -20~0° C	tAH tAH		10	-	10					
Peripheral Read Access Times (t _{Cyc} -t _{Ef} -t _{AD} -t _{DSR} *t _{ACC})		¹ ACC	Fig. 1, 2	330	_	-	185		-	ns	
Data Setup Time (Read)		tDSR		40	-	_	20			ns	
Input Data Hold Time Data Delay Time (Write)		†DHR]	20	_	-	20	. 1		ns	
		tDDW	1	-		110	-		70	ns	
	Ta = 0~75°C	1 1	1 F		30	-		30			ns
Output Data Hold Time	Ta = -20~0°C	tDHW		20	_	-	20				

3. PROCESSOR CONTROL TIMING

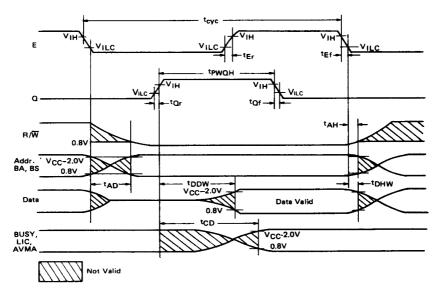
				HD63B09	E		HD63C09	E	Unit	
ltem	Symbol	Test Condition	min	typ	mex	min	typ	max	Oiiit	
Control Delay (BUSY, LIC, AVMA)	^t CD			-	200		_	130	ns	
Interrupts Set Up Time	tPCS	'	110		-	70			ns	
HALT Set Up Time	ФCS		110		_	70			ns	
RES Set Up Time	^t PCS		110			70	<u></u>		ns	
TSC Setup Time	tPCS	Fig. 1, 2,	110	-		70		_	ns	
TSC Drive to Valid Logic Levels	†TSA	7 ~ 10, 14 and 17	_	_	120	1	_	120	ns	
TSC Release MOS Buffers to High Impedance	†TSR		_	_	110	_	_	110	ns	
TSC Three-State Delay	tTSD		_	 	80	-	_	80	ns	
Processor Control Rise/Fall	tPCr. tPCf		_		100	_	T	100	ns	
TSC input Delay	TPCT		30	-	_	30	T -	-	ns	





(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 1 Read Data from Memory or Peripherals



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 2 Write Data to Memory or Peripherals

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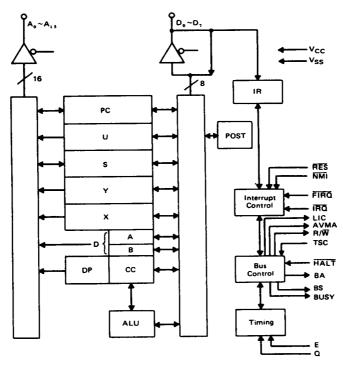
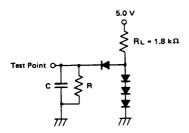


Figure 3 HD6309E Expanded Block Diagram



C = 30 pF for BA, BS, LIC, AVMA, BUSY 130 pF for $D_0 \sim D_7$ 90 pF for $A_0 \sim A_{15}$, R/W

R = 10 kΩ for D₀ ~ D₇ 10 kΩ for A₀ ~ A₁₅, R/W 10 kΩ for BA, BS, L1C, AVMA, BUSY

All diodes are 1S2074(H) or equivalent. C includes stray capacitance.

Figure 4 Bus Timing Test Load

PROGRAMMING MODEL

As shown in Figure 5, the HD6309E adds three registers to the set available in the HD6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register.

Accumulators (A, B, D)

The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D Register, and is formed with the A Register as the most significant byte.

Direct Page Register (DP)

The Direct Page Register of the HD6309E serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A₈ ~ A₁₅) during direct addressing instruction execution. This allows the direct mode to be used at any place in memory, under program control. To ensure HD6800 compatibility, all bits of this register are cleared during Processor Reset.

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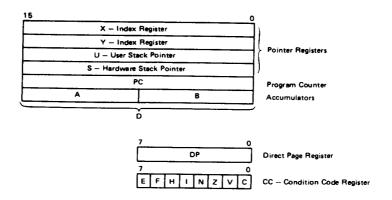


Figure 5 Programming Model of The Microprocessing Unit

Index Registers (X, Y)

The Index Registers are used in indexed mode of addressing. The 16-bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modified by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data. All four pointer registers (X, Y, U, S) may be used as index registers.

Stack Pointer (U, S)

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts. The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. The U-register is frequently used as a stack marker. Both Stack Pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support Push and Pull instructions. This allows the HD6309E to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

(NOTE) The stack pointers of the HD6309E point to the top of the stack, in contrast to the HD6800 stack pointer, which pointed to the next free location on stack.

Program Counter (PC)

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

Condition Code Register (CC)

The Condition Code Register defines the state of the processor at any given time. See Figure 6.

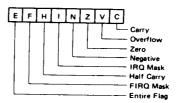


Figure 6 Condition Code Register Format

■ CONDITION CODE REGISTER DESCRIPTION

Bit 0 (C)

Bit 0 is the carry flag, and is usually the carry from the binary ALU. C is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

Bit 1 (V)

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

Bit 2 (Z)

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero.

Bit 3 (N)

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one.

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Bit 4 (1)

Bit 4 is the IRQ mask bit. The processor will not recognize interrupts from the IRQ line if this bit is set to a one. NMI, FIRQ, IRQ, RES and SWI all set I to a one; SWI2 and SWI3 do not affect I.

Bit 5 (H)

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions.

• Bit 6 (F)

Bit 6 is the FIRQ mask bit. The processor will not recognize interrupts from the FIRQ line if this bit is a one. NMI, FIRQ, SWI, and RES all set F to a one. IRQ, SWI2 and SWI3 do not affect F.

• Bit 7 (E)

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the Condition Code Register represents past action.

m HD6309E MPU SIGNAL DESCRIPTION

• Power (VSS, VCC)

Two pins are used to supply power to the part: Vss is ground or 0 volts, while Vcc is +5.0 V ±10%.

Address Bus (A₀ ∼ A₁₅)

Sixteen pins are used to output address information from the MPU onto the Address Bus. When the processor does not require the bus for a data transfer, it will output address FFFF₁₆, R/W = "High", and BS = "Low"; this is a "dummy access" or VMA cycle. All address bus drivers are made high-impedance when output Bus Available (BA) is "High" or when TSC is asserted. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF. Refer to Figures 1 and 2.

● Data Bus (D₀ ~ D₇)

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and 130 pF.

Read/Write (R/W)

This signal indicates the direction of data transfer on the data bus. A "Low" indicates that the MPU is writing data-onto the data bus. R/W is made high impedance when BA is "High" or when TSC is asserted. Refer to Figures 1 and 2.

• RES

A "Low" level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7. The Reset vectors are fetched from locations FFFE₁₆ and FFFF₁₆ (Table 1) when Interrupt Acknowledge is true, (BA · BS = 1). During initial power-on, the Reset line should be held "Low" until the clock input signals are fully operational.

Because the HD6309E Reset pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system.

This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor.

Table 1 Memory Map for Interrupt Vectors

Memory Ma Locat	p for Vector ions	Interrupt Vector Description
MS	LS	Description
FFFE	FFFF	RES
FFFC	FFFD	NMI
FFFA	FFFB	SWI
FFF8	FFF9	IRO
FFF6	FFF7	FIRO
FFF4	FFF5	SWI2
FFF2	FFF3	SWI3
FFF0	FFF1	Reserved

• HALT

A "Low" level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven "High" indicating the buses are high impedance. BS is also "High" which indicates the processor is in the Halt state. While halted, the MPU will not respond to external real-time requests (FIRQ, IRQ) although NMI or RES will be latched for later response. During the Halt state Q and E should continue to run normally. A halted state (BA · BS = 1) can be achieved by pulling HALT "Low" while RES is still "Low". See Figure 8.

Bus Available, Bus Status (BA, BS)

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. When BA goes "Low", a dead cycle will elapse before the MPU acquires the bus. BA will not be asserted when TSC is active, thus allowing dead cycle consistency.

The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q).

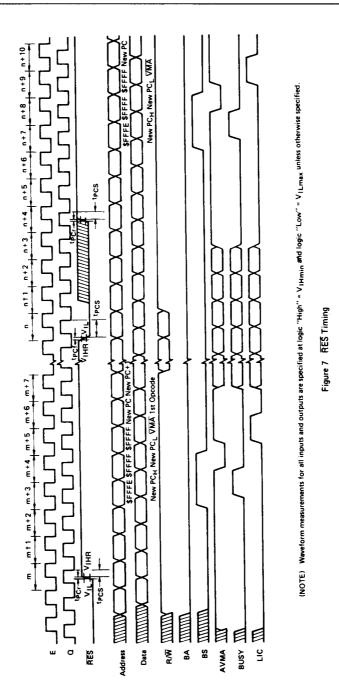
MPL	State	MPU State Definition				
ВА	BS	MPO State Definition				
0	0	Normal (Running)				
0	1	Interrupt or RESET Acknowledge				
1	0	SYNC Acknowledge				
1	1	HALT Acknowledge				

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch (RES, NMI, FIRQ, IRQ, SWI, SWI2, SWI3). This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1

Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

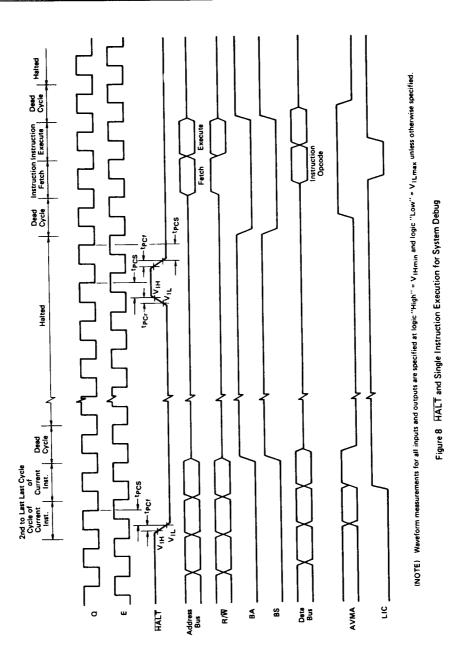
Halt Acknowledge is indicated when the HD6309E is in a Halt condition.





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■ Non Maskable Interrupt (NMI)*

A negative transition on this input requests that a non-maskable interrupt sequence be generated. A non-maskable interrupt cannot be inhibited by the program, and also has a higher priority than FIRQ, IRQ or software interrupts. During recognition of an NMI, the entire machine state is saved on the hardware stack. After reset, an NMI will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of NMI low must be at least one E cycle. If the NMI input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Figure 9.

• Fast-Interrupt Request (FIRQ)*

A "Low" level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request (IRQ), and is fast in the sense that it stacks only the contents the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 10.

● Interrupt Request (IRQ)*

A "Low" level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since \overline{IRQ} stacks the entire machine state it provides a slower response to interrupts than \overline{FIRQ} . \overline{IRQ} also has a lower priority than \overline{FIRQ} . Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 9.

• NMI, FIRQ, and IRQ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWAI condition is present. If IRQ and FIRQ do not remain "Low" until completion of the current instruction they may not be recognized. However, NMI is latched and need only remain "Low" for one cycle.

Clock Inputs E, Q

E and Q are the clock signals required by the HD6309E. Q must lead E; that is, a transition on Q must be followed by a similar transition on E after a minimum delay. Addresses will be valid from the MPU, taD after the falling edge of E, and data will be latched from the bus by the falling edge of E. While the Q input is fully TTL compatible, the E input directly drives internal MOS circuitry and, thus, requires levels above normal TTL levels. This approach minimizes clock skew inherent with an internal buffer. Timing and waveforms for E and Q are shown in Figures 1 and 2 while Figure 11 shows a simple clock generator for the HD6309E.

BUSY

Busy will be "High" for the read and modify cycles of a readmodify-write instruction and during the access of the first byte of a double-byte operation (e.g., LDX, STD, ADDD). Busy is also "High" during the first byte of any indirect or other vector fetch (e.g., jump extended, SWI indirect etc.).

In a multi-processor system, busy indicates the need to defer the rearbitration of the next bus cycle to insure the integrity of the above operations. This difference provides the indivisible memory access required for a "test-and-set" primitive, using any one of several read-modify-write instructions.

Busy does not become active during PSH or PUL operations. A typical read-modify-write instruction (ASL) is shown in Figure 12. Timing information is given in Figure 13. Busy is valid top after the rising edge of O.

AVMA

AVMA is the Advanced VMA signal and indicates that the MPU will use the bus in the following bus cycle. The predictive nature of the AVMA signal allows efficient shared-bus multiprocessor systems. AVMA is "Low" when the MPU is in either a HALT or SYNC state. AVMA is valid t_{CD} after the rising edge of O.

LIC

LIC (Last Instruction Cycle) is "High" during the last cycle of every instruction, and its transition from "High" to "Low" will indicate that the first byte of an opcode will be latched at the end of the present bus cycle. LIC will be "High" when the MPU is Halted at the end of an instruction, (i.e., not in CWAI or RESET) in SYNC state or while stacking during interrupts. LIC is valid t_{CD} after the rising edge of Q.

• TSC

TSC (Three-State Control) will cause MOS address, data, and R/W buffers to assume a high-impedance state. The control signals (BA, BS, BUSY, AVMA and LIC) will not go to the high-impedance state. TSC is intended to allow a single bus to be shared with other bus masters (processors or DMA controllers).

While E is "Low", TSC controls the address buffers and R/W directly. The data bus buffers during a write operation are in a high-impedance state until Q rises at which time, if TSC is true, they will remain in a high-impedance state. If TSC is held beyond the rising edge of E, then it will be internally latched, keeping the bus drivers in a high-impedance state for the remainder of the bus cycle. See Figure 14.

MPU Operation

During normal operation, the MPU fetches an instruction from memory and then executes the requested function. This sequence begins after RES and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: SWI, SWI2, SWI3, CWAI, RTI and SYNC. An interrupt or HALT input can also alter the normal execution of instructions. Figure 15 illustrates the flow chart for the HD6309E.



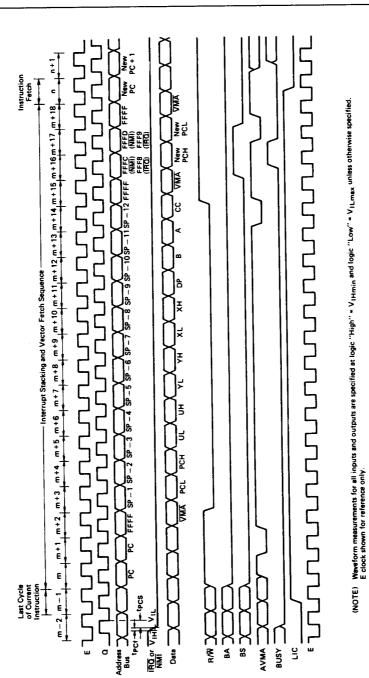
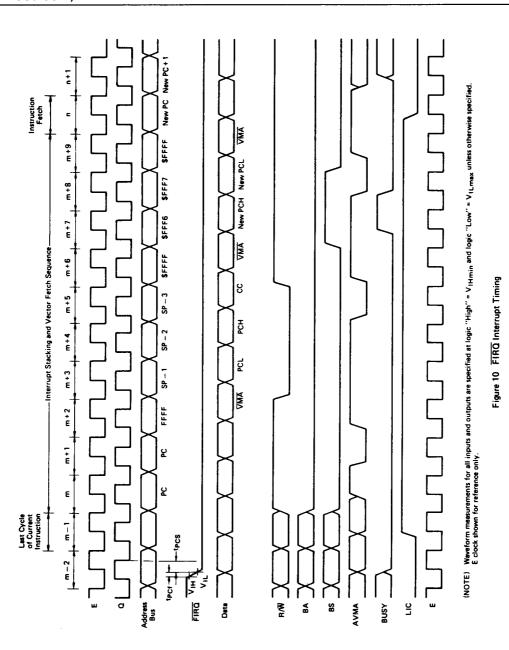


Figure 9 IRO and NMI Interrupt Timing

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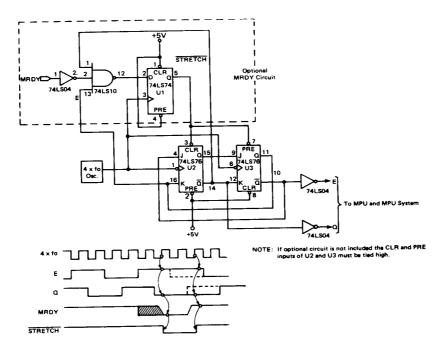


Figure 11 HD6309E Clock Generator

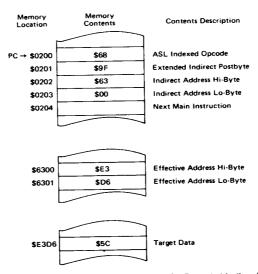


Figure 12 Read Modify Write Instruction Example (ASL Extended Indirect)

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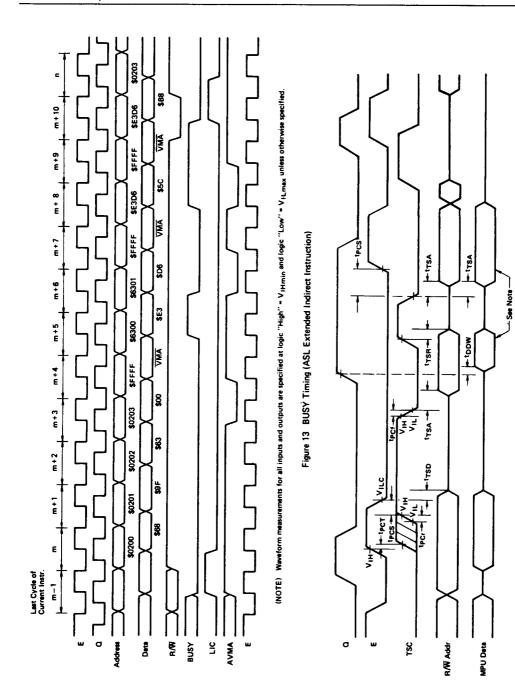


Figure 14 TSC Timing

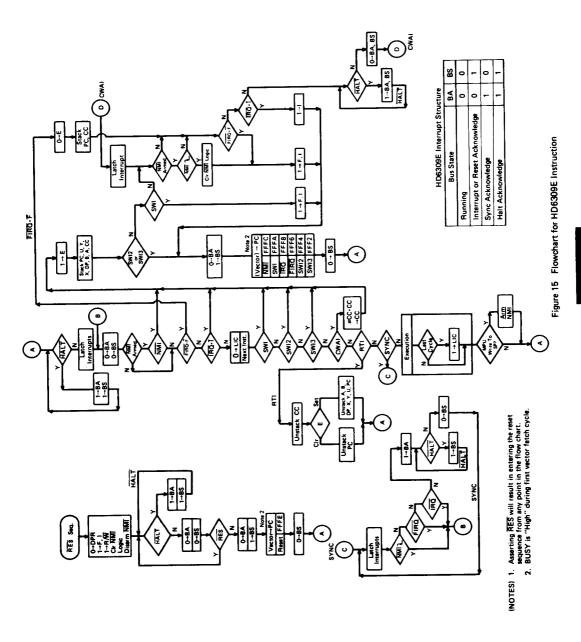
(NOTES) Data will be asserted by the MPU only during the interval while R/W is "Low" and E or Q is "High".
Waveform measurements for all inputs and outputs are specified at logic "High": = VIHmin and logic "Low" = V_{1Lmax} unless otherwise specified.

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- ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The HD6309E has the most complete set of addressing modes available on any microcomputer today. For example, the HD6309E has 59 basic instructions; however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the HD6309E:

- (1) Implied (Includes Accumulator)
- (2) Immediate
- (3) Extended
- (4) Extended Indirect
- (5) Direct
- (6) Register
- (7) Indexed

Zero-Offset

Constant Offset

Accumulator Offset

Auto Increment/Decrement

- (8) Indexed Indirect
- (9) Relative
- (10) Program Counter Relative

Implied (Includes Accumulator)

In this addressing mode, the opcode of the instruction contains all the address information necessary. Examples of Implied Addressing are: ABX, DAA, SWI, ASRA, and CLRB.

Immediate Addressing

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i.e., the data to be used in the instruction immediately follows the opcode of the instruction). The HD6309E uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode. Examples of instructions with Immediate Addressing are:

LDA #\$20 LDX #\$F000

LDY #CAT

(NOTE) # signifies immediate addressing, \$ signifies hexadecimal value.

Extended Addressing

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include:

LDA CAT

STX MOUSE

LDD \$2000

Extended Indirect

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing. In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data.

LDA [CAT]

LDX [\$FFFE]

STU [DOG]

Direct Addressing

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8 bits of the address to be used. The upper 8 bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on Reset, direct addressing on the HD6309E is compatible with direct addressing on the HD6800. Indirection is not allowed in direct addressing. Some examples of direct addressing are:

LDA \$30 SETDP \$10 (Assembler directive) LDB \$1030 LDD <CAT

(NOTE) < is an assembler directive which forces direct addressing.

Register Addressing

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing are:

TFR X, Y Transfer X into Y
EXG A, B Exchanges A with B
PSHS A, B, X, Y Push Y, X, B and A onto S
PULU X, Y, D Pull D, X, and Y from U

Indexed Addressing

In all indexed addressing, one of the pointer registers (X, Y, U, S, and sometimes PC) is used in a calculation of the effective address of the operand to be used by the instruction. Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 16 lists the legal formats for the postbyte. Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation.

		Post-E	Byte	Regis	ter B	it		Indexed
7 (6	5	4	3	2	1	0	Addressing Mode
	R	R	d	d	d	đ	Q	EA = ,R + 5 Bit Offset
1	A	R	0	0	0	0	0	,я +
1 1	R	R)	0	0	0	1	,R++
1 1	A	P	0	0	0	1	0	, -R
1 1	R	R	÷	0	0	1	1	,R
111	R	#	i	0	1	0	0	EA = ,R + 0 Offset
1 1	R	R	-	0	1	0	1	EA = ,R + ACCS Offse
1 1	R	A	- 1	0	. 1	1	ि	EA = ,R + ACCA Offee
1 1	R	R	i	1	0	0	0	EA = , R + 8 Bit Offs
<u> </u>	R	R	í	1	0	0	1	EA = ,R + 16 Bit Offpe
7 7	R	R		1	0	1	1	EA = ,R + D Offset
1 7	۳,	×	i	1	,	0	0	EA - PC + 8 Bit Offset
1	Ĩ	×		1	1	0	1	EA = ,PC + 16 Bit Offs
1 F	Ą	R	-	1	1	1	1	EA = [,Address]
_	Ì		Ī			Ĺ		— Addressing Mode Field Indirect Field
			-					(Sigh bit when 57 = 0)
Don't	ا .							Register Field : RR 00 = X 01 = Y

Figure 16 Index Addressing Postbyte Register Bit Assignments

10 - U

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Table 2 Indexed Addressing Mode

		N	on Indirect				Indirect		
Туре	Forms	Assembler	Postbyte OP Code	+ ~	+ #	Assembler Form	Postbyte OP Code	+ ~	+ #
Constant Offset From R	No Offset	.R	1RR00100	0	0	[,R]	1RR10100	3	0
(2's Complement Offsets)	5 Bit Offset	n, R	0RRnnnnn	1	0	default	ts to 8-bit		L.
	8 Bit Offset	n, R	1RR01000	1	1	[n, R]	1RR11000	4	1
	16 Bit Offset	n, R	1RR01001	4	2	[n, R]	1RR11001	7	2
Accumulator Offset From R (2's Complement Offsets)	A Register Offset	A, R	1RR00110	1	0	[A, R]	1RR10110	4	0
	B Register Offset	B, R	1RR00101	1	0	[B, R]	1RR10101	4	0
	D Register Offset	D, R	1RR01011	4	0	[D, R]	1RR11011	7	0
Auto Increment/Decrement R	Increment By 1	,R +	1RR00000	2	0	not allowed			L
Auto Increment/Decrement N	Increment By 2	,R++	1RR00001	3	0	[,R++]	1RR10001	6	0
	Decrement By 1	, - R	1RR00010	2	0	not	allowed	Т	
	Decrement By 2	R	1RR00011	3	0	[, R]	1RR10011	6	0
Out of Company	8 Bit Offset	n, PCR	1xx01100	1	1	[n, PCR]	1xx11100	4	1
Constant Offset From PC (2's Complement Offsets)	16 Bit Offset	n, PCR	1xx01101	5	2	[n, PCR]	1xx11101	8	2
Extended Indirect	16 Bit Address			1-	1-	[n] 1001111		5	2

R = X, Y, U or S

RR. $\Omega \Omega = X$

x = Don't Care

01 = Y

10 = U

Zero-Offset Indexed

In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are:

LDD 0, X

LDA S

Constant Offset Indexed

In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand. The pointer register's initial content is unchanged by the addition.

Three sizes of offsets are available:

5-bit (-16 to +15)

8-bit (-128 to +127) 16-bit (-32768 to +32767)

The two's complement 5-bit offset is included in the post-

byte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are:

LDA 23, X

LDX -2.S

300, X LDY LDU CAT, Y

Accumulator-Offset Indexed

This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators (A, B or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:

LDA B, Y

LDX D, Y

LEAX B, X

Auto Increment/Decrement Indexed

In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data. The use of auto decrement is similar to that of auto increment; but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8- or 16-bit data to be accessed and is selectable by the programmer. The pre-

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 $[\]stackrel{+}{\sim}$ and $\stackrel{+}{\pm}$ indicate the number of additional cycles and bytes for the particular variation.

decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the U and S stacks.

Some examples of the auto increment/decrement addressing

LDA , X + STD , Y + + LDB , - Y LDX . - - S

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address.

Consider the following instruction:

STX 0, X + + (X initialized to 0)

The desired result is to store a 0 in locations \$0000 and \$0001 then increment X to point to \$0002. In reality, the following occurs:

0 → temp calculate the EA; temp is a holding register perform autoincrement X → (temp) do store operation

Indexed Indirect

All of the indexing modes with the exception of auto increment/decrement by one, or a ±4-bit offset may have an additional level of indirection specified. In indirect addressing, the effective address is contained at the location specified by the contents of the Index Register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index Register and an offset.

Before Execution
A = XX (don't care)
X = \$F000
\$0100 LDA [\$10, X] EA is now \$F010
\$F010 \$F1 \$F150 is now the
\$F011 \$50 new EA
\$F150 \$AA
After Execution
A = \$AA (Actual Data Loaded)
X = \$F000

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are:

LDA [, X] LDD [10, S] LDA [B, Y] LDD [, X++]

Relative Addressing

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter. Program execution continues at the new location as indicated by the PC; short (1 byte offset) and long (2 bytes offset) relative addressing modes are available. All of memory can be reached in long relative addressing as an effective address is interpreted modulo 2¹⁶. Some examples of relative addressing are:

BEQ CAT (short)
BGT DOG (short)

CAT DOG	LBEQ LBGT	RAT RABBIT	(long) (long)
	•		
	•		
RAT	NOP		
RARRIT	NOP		

Program Counter Relative

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program Counter Relative Addressing is used for writing position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter. Examples are:

LDA CAT, PCR LEAX TABLE, PCR

Since program counter relative is a type of indexing, an additional level of indirection is available.

LDA [CAT, PCR] LDU [DOG, PCR]

■ HD6309E INSTRUCTION SET

The instruction set of the HD6309E is similar to that of the HD6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

Some of the instructions are described in detail below:

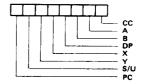
PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction.

• PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed; each bit defines a unique register to push or pull, as shown in below.

PUSH/PULL POST BYTE



	← P	ull Or	der	P	ush O	rder →	
PC	U	Y	Х	DP	В	A	CC
FFFF	← iı	ncreasi	ng me	mory a	ddre	s	0000
PC	S	Y	X	DP	В	A	CC



TFR/EXG

Within the HD6309E, any register may be transferred to or exchanged with another of like-size; i.e., 8-bit to 8-bit or 16-bit to 16-bit. Bits $4\sim7$ of postbyte define the source register, while bits $0\sim3$ represent the destination register. These are denoted as follows:

0000 - D	0101 - PC
0001 - X	1000 - A
0010 - Y	1001 — B
0011 U	1010 - CC
0100 - S	1011 – DP

(NOTE) All other combinations are undefined and INVALID.

TRANSFER/EXCHANGE POST BYTE

	1 1 1
SOURCE	DESTINATION
50002	1 5

LEAX/LEAY/LEAU/LEAS

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer. Some of the implications of this instruction are illustrated in Table 3.

The LEA instruction also allows the user to access data in a position independent manner. For example:

	LEAX LBSR	MSG1, PCR PDATA (Print message routine)
	•	
	•	
MSG1	FCC	'MESSAGE'

This sample program prints: 'MESSAGE'. By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the X pointer register. This code is totally position independent.

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows:

LEAa, b+ (any of the 16-bit pointer registers X, Y, U or S may be substituted for a and b.)

1. b
$$\rightarrow$$
 temp (calculate the EA)

2. b + 1 \rightarrow b (modify b, postincrement)

3. temp \rightarrow a (load a)

LEAa, \rightarrow b

1. b - 1 \rightarrow temp (calculate EA with predecrement)

2. b - 1 \rightarrow b (modify b, predecrement)

Autoincrement-by-two and autodecrement-by-two instructions work similarly. Note that LEAX, X+ does not change X, however LEAX, -X does decrement X. LEAX 1, X should be used to increment X by one.

(load a)

3. temp \rightarrow a

Table 3 LEA Examples

Instruction	Operation	Comment
LEAX 10, X	X + 10 → X	Adds 5-bit constant 10 to X
LEAX 500, X	X + 500 → X	Adds 16-bit constant 500 to X
LEAY A.Y	Y+A →Y	Adds 8-bit A accumulator to Y
LEAY D.Y	$Y + D \rightarrow Y$	Adds 16-bit D accumulator to Y
LEAU -10, U		Subtracts 10 from U
LEAS -10, S		Used to reserve area on stack
LEAS 10, S	S + 10 → S	Used to 'clean up' stack
LEAX 5, S	\$+5 → X	Transfers as well as adds

· MIII

Multiplies the unsigned binary numbers in the A and B accumulator and places the unsigned result into the 16-bit D accumulator. This unsigned multiply also allows multiple-precision multiplications.

Long and Short Relative Branches

The HD6309E has the capability of program counter relative branching throughout the entire memory map. In this mode, if the branch is to be taken, the 8 or 16-bit signed offset is added to the value of the program counter to be used as the effective address. This allows the program to branch anywhere in the 64k memory map. Position independent code can be easily generated through the use of relative branching. Both short (8-bit) and long (16-bit) branches are available.

• SYNC

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt. If the pending interrupt is non-maskable (FIRQ, IRQ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine. Since FIRQ and IRQ are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken. If the pending interrupt is maskable (FIRQ, IRQ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction. Figure 17 depicts Sync timing.

Software Interrupts

A Software Interrupt is an instruction which will cause an interrupt, and its associated vector fetch. These Software Interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on this HD6309E, and are prioritized in the following order: SWI, SWI2, SWI3.

16-Bit Operation

The HD6309E has the capability of processing 16-bit data. These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls.

■ CYCLE-BY-CYCLE OPERATION

The address bus cycle-by-cycle performance chart illustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the HD6309E. Each instruction begins with an opcode fetch. While that opcode is being internally decoded, the next program byte is always fetched. (Most instructions will use the next byte, so this

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technique considerably speeds throughput.) Next, the operation of each opcode will follow the flow chart. \overline{VMA} is an indication of FFFF₁₆ on the address bus, R/\overline{W} = "High" and BS = "Low". The following examples illustrate the use of the chart; see Figure 18.

Example 1: LBSR (Branch Taken) Before Execution SP = F000

		•		
		•		
\$8000		LBSR		CAT
		•		
\$A000	CAT			
		CYCLE	E-BY-CY	CLE FLOW
Cycle #	Address	Data	R/\overline{W}	Description
i	8000	17	ì	Opcode Fetch
2	8001	1 F	1	Offset High Byte
3	8002	FD	1	Offset Low Byte
4	FFFF	*	1	VMA Cycle
5	FFFF	*	ì	VMA Cycle
6	FFFF	*	1	VMA Cycle
7	FFFF	*	1	VMA Cycle
8	EFFF	03	0	Stack Low Order
				Byte of Return

Address

Stack High Order Byte of Return Address

Example 2: DEC (Extended)

EFFE

9

*0000

28000	DEC	Ľ	3A()00
\$A000	FCI	В	\$80)
		CYCL	E-BY-CY	CLE FLOW
Cycle #	Address	Data	R/\overline{W}	Description
1	8000	7A	1	Opcode Fetch
2	8001	A0	1	Operand Address,
				High Byte
3	8002	00	1	Operand Address,
				Low Byte
4	FFFF	*	1	VMA Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	VMA Cycle
7	A000	7 F	0	Store the Decre-
				mented Data

80

0

SLEEP MODE

During the interrupt wait period in the SYNC instruction (the SYNC state) and that period in the CWAI instruction (the WAIT state), MPU operation is halted and goes to the sleep mode. However, the state of I/O pins is the same as that of the HD6809E in this mode.

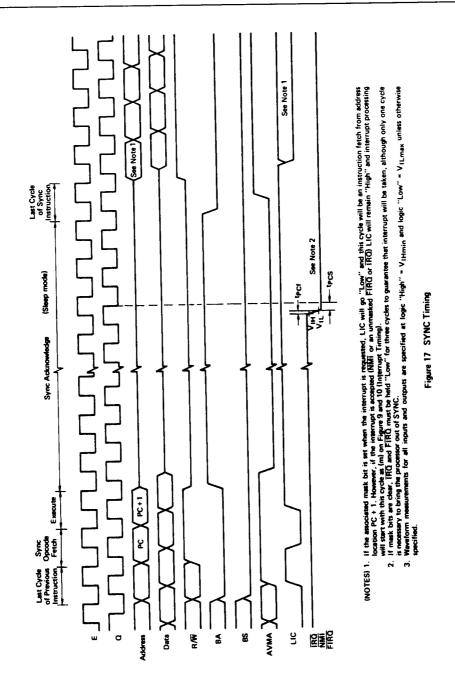
■ HD6309E INSTRUCTION SET TABLES

The instructions of the HD6309E have been broken down into five different categories. They are as follows:

8-Bit operation (Table 4)
16-Bit operation (Table 5)
Index register/stack pointer instructions (Table 6)
Relative branches (long or short) (Table 7)
Miscellaneous instructions (Table 8)

HD6309E instruction set tables and Hexadecimal Values of instructions are shown in Table 9 and Table 10.

^{*} The data bus has the data at that particular address.



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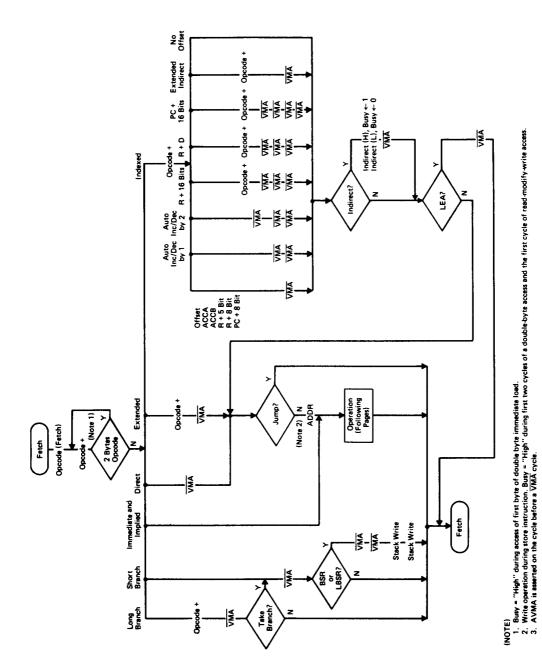
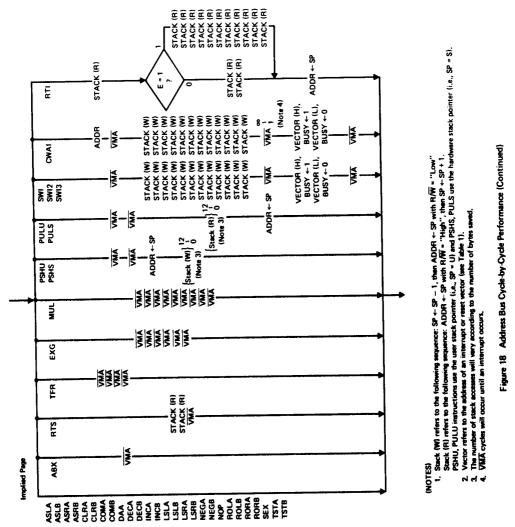


Figure 18 Address Bus Cycle-by-Cycle Performance

2



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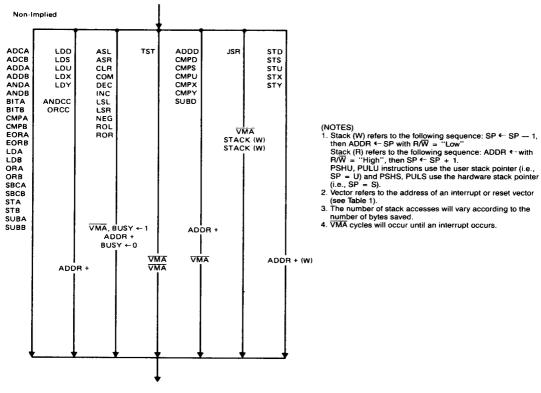


Figure 18 Address Bus Cycle-by-Cycle Performance (Continued)

Table 4 8-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation	
ADCA, ADCB	Add memory to accumulator with carry	
ADDA, ADDB	Add memory to accumulator	
ANDA, ANDB	And memory with accumulator	
ASL, ASLA, ASLB	Arithmetic shift of accumulator or memory left	
ASR, ASRA, ASRB	Arithmetic shift of accumulator or memory right	
BITA, BITB	Bit test memory with accumulator	
CLR, CLRA, CLRB	Clear accumulator or memory location	
CMPA, CMPB	Compare memory from accumulator	
COM, COMA, COMB	Complement accumultor or memory location	
DAA	Decimal adjust A accumulator	
DEC, DECA, DECB	Decrement accumulator or memory location	
EORA, EORB	Exclusive or memory with accumulator	
EXG R1, R2	Exchange R1 with R2 (R1, R2 = A, B, CC, DP)	
INC, INCA, INCB	Increment accumulator or memory location	
LDA, LDB	Load accumulator from memory	
LSL, LSLA, LSLB	Logical shift left accumulator or memory location	
LSR, LSRA, LSRB	Logical shift right accumulator or memory location	

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(Continued)

300

Table 4 8-Bit Accumulator and Memory Instructions (Continued)

Mnemonic(s)	Operation
MUL	Unsigned multiply $(A \times B \rightarrow D)$
NEG, NEGA, NEGB	Negate accumulator or memory
ORA, ORB	Or memory with accumulator
ROL, ROLA, ROLB	Rotate accumulator or memory left
ROR, RORA, RORB	Rotate accumulator or memory right
SBCA, SBCB	Subtract memory from accumulator with borrow
STA, STB	Store accumulator to memory
SUBA, SUBB	Subtract memory from accumulator
TST, TSTA, TSTB	Test accumulator or memory location
TER R1, R2	Transfer R1 to R2 (R1, R2 = A, B, CC, DP)

(NOTE) A, B, CC or DP may be pushed to (pulled from) either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 5 16-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation
ADDD	Add memory to D accumulator
CMPD	Compare memory from D accumulator
EXG D, R	Exchange D with X, Y, S, U or PC
LDD	Load D accumulator from memory
SEX	Sign Extend 8 accumulator into A accumulator
STD	Store D accumulator to memory
SUBD	Subtract memory from D accumulator
TFR D, R	Transfer D to X, Y, S, U or PC
TFR R, D	Transfer X, Y, S, U or PC to D

(NOTE) D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 6 Index Register Stack Pointer Instructions

Mnemonic(s)	Operation
CMPS, CMPU	Compare memory from stack pointer
CMPX, CMPY	Compare memory from index register
EXG R1, R2	Exchange D, X, Y, S, U or PC with D, X, Y, S, U or PC
LEAS, LEAU	Load effective address into stack pointer
LEAX, LEAY	Load effective address into index register
LDS, LDU	Load stack pointer from memory
LDX, LDY	Load index register from memory
PSHS	Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack
PSHU	Push A. B. CC, DP, D, X, Y, S, or PC onto user stack
PULS	Pull A, B, CC, DP, D, X, Y, U or PC from hardware stack
PULU	Pull A, B, CC, DP, D, X, Y, S or PC from user stack
STS, STU	Store stack pointer to memory
STX, STY	Store index register to memory
TFR R1, R2	Transfer D, X, Y, S, U or PC to D, X, Y, S, U or PC
ABX	Add B accumulator to X (unsigned)

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Table 7 Branch Instructions

Mnemonic(s)	Operation
	SIMPLE BRANCHES
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BMI, LBMI	Branch if minus
BPL, LBPL	Branch if plus
BCS, LBCS	Branch if carry set
BCC, LBCC	Branch if carry clear
BVS, LBVS	Branch if overflow set
BVC, LBVC	Branch if overflow clear
	SIGNED BRANCHES
BGT, LBGT	Branch if greater (signed)
BGE, LBGE	Branch if greater than or equal (signed)
BEQ, LBEQ	Branch if equal
BLE, LBLE	Branch if less than or equal (signed)
BLT, LBLT	Branch if less than (signed)
	UNSIGNED BRANCHES
BHI, LBHI	Branch if higher (unsigned)
BHS, LBHS	Branch if higher or same (unsigned)
BEQ, LBEQ	Branch if equal
BLS, LBLS	Branch if lower or same (unsigned)
BLO, LBLO	Branch if lower (unsigned)
	OTHER BRANCHES
BSR, LBSR	Branch to subroutine
BRA, LBRA	Branch always
BRN, LBRN	Branch never

Table 8 Miscellaneous Instructions

Mnemonic(s)	Operation
ANDCC	AND condition code register
CWAI	AND condition code register, then wait for interrupt
NOP	No operation
ORCC	OR condition code register
JMP	Jump
JSR	Jump to subroutine
RTI	Return from interrupt
RTS	Return from subroutine
SWI, SWI2, SWI3	Software interrupt (absolute indirect)
SYNC	Synchronize with interrupt line

Table 9. HD6309E Instruction Set Table

INSTRU	CTIONS/	AC	M	RE	ا_ن	DIR	EC.	T	E	CTN	D	11	MME	D	IN	DE	ΧŒ	RE	LA	rivi		DESCRIPTION	7 E	6 F	5 H	4	3 N	2 Z	1 V	0 C
	RMS	O P	Ξ	#	0	Р	-	#	ΟP	~	#	O P	=	#	O P	1-	#	01	1~0	*									_	•
ABX		3 A	3	ı			- {	ļ	'			Ì		ĺ	1						1	B + X → X (UNSIGNED)	•	•	•	•	•	•	•	•
				İ	-	-	i				ļ	1		١.	١	١.						A + M + C → A	•	•	1	•	;	:	1	1
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	UCTIONS/	AC	ĊЙ	RE	G I	HRE	_	_	EXT			MM					RE			DESCRIPTION	7	6	5	4	3	2	1	ı l
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																	2 1											
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	ORB				D	A	4	2 F	· A	5	3 (-	• •	12 '		Ţ		CC∨ IMM→CC	- } .	ι+	-	-10	⊅ ⊢	-	-	+
	ORCC	İ					1	1	1		- 13	A	3	2	l			ì	1		Push Registers on	1	ه ا د	əle	• 6	• •	• •	• •	•
PSH	PSHS	3 4	5+3	î i	}	ì		-1		1		-	Ì		1			1			S Stack	- [-		1	ļ	- 1		- 1	- [
			į.	1		- 1		- 1		- 1	- 1		- 1								Push Registers on	10		• i •	• •	• •	• 6	• 1	•
	PSHU	3 6	å 5 ÷.	î :	2		1	- 1		ļ	1	- İ	-	- 1				1		- }	U Stack	1	1	-	- 1	-		1	ĺ
		- -	1		1			j		- 1		1		-			Ì		1		Pull Registers	- [,1	\dashv		oo ↓	_	_	4
PUL	PULS	3.5	5 5+	ŝ.	2	ı	ļ	1			- 1	- 1	-				Į.	1			from S Stack		`	1	- []			- [
			i.	-				1	İ		- 1	- 1	ı	1					i		Pull Registers		,1	\perp		o.↓	_		_
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			1	1						į		- 1					ì			1	from U Stack		1	- 1	- 1	- 1		- 1	
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ROR	RORA	4	6	2	1											ļ	1	ı	-		A		•	•		- 1	1	:	-
KOK	RORB		6		i	- {									ì	1	1	1		- 1			_	•	- 1		1		:
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	KOK	ļ			-		_	_	'	1				l	Į.	1	1	Ì	-	ļ	1	•	- 1	. i	. 1		Ì	- [
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		1,	9	_	ı			l		i	1	{]		l		1			- i	- 1	Return from	ĺ	•	•	.●	•	•	•	•
RTS		3	3	٠	.					1						1	ļ			Į	Subroutine				ا ـ ا	1.1	إرا	ا , ا	
	cnc+		-	J		9 2	4	,	B 2	5	3	8 2	2	2	A:	2 4	+ 2	2 +		- !	A - M - C → A	-	•	•	8	•	1	:	į
SBC	SBCA	Ì		Ì		D 2			F 2			C 2				2 4			Ì		B - M - C → B		•	•	80	•	1	1	1
	SBCB	1.		٦		102	1	' ا	1 2	1	ľ	1	٦	1	1	ľ	1	- 1			Sign Extend B into A		•	•	$ \bullet $		1	1	•
SEX		1	D	2	1						Ì			İ							(BOE , 17=1 FF→	A	- 1		1	i 1	į !		
							1				1	1									BOE 17=0 0→								
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			ì		1	1	1	1	1	1	1	1	1	1	1	1	- 1	- 1			1 1			1	1	1	i .	<u> </u>	_

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£0				REC			CT		XT	•••		MM		11.	DE:	^w	NE	LAI	IVE	·I	7	6	5	4	3	2	1	10
' ' '	RMS	O P	-	#	O P	Ι-	#	O P	-	#	O P	-	#	ОP	-	#	O P	~6	#	DESCRIPTION	E	F	Н	†	N	Z	v	-
sτ	STA	1			9 7	4	2	B 7	5	3	T	Ī		A 2	4 +	12.	T		T .	A→M	-		Ë	+	† –		-	+
	STB		ļ		D 7		2		5	3					4 +	1-				B→M	-	-	-		1	1	R	1 -
	STD			l	DD	1 '		FD		3		İ	,		5 +					D→M:M+1		•		•	1	1	R	
	STS	1			10	1 -	3		7	4]			1	6 +	1-	1			S→M:M+1	- -	•	•		1	1	R	
					DF	1 -	"	FF	l '	1	Ĭ			EF	1 -	3 7				2 → M:M+ 1	-	•	•	•	1	1	R	1
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	STY				10	1	3	1	7	4					6 +	ŀ	1			Y→M:M+1		-	•	-	1	1	R	1 -
					9 F	1 -	ľ	BF	ļ '	1				A F	1	.		ļ	İ	1 -14:14:1	_	•	•	•	1	1	R	1
eun.																												
SUB	SUBA				9 0	4		B 0			8 0			A 0				İ		A~M→A	•	•	8	•	t	1	t	1
	SUBB	1			D 0	4	ı	F 0			C 0	- 1		E 0		ı				B−M→B	•	•	8		1	1	1	1
	SUBD			ł	9 3	6	2	B 3	7	3	8 3	4	3	A 3	6 +	2 +			i	D - M:M + 1 → D	•	•	•	•	1	t	1	:
SWI	SWI6	3 F	ı	1			ĺ													Software interrupt 1	s	s	•	s	•	•	•	
	SW126	10		2	1 :			li												Software interrupt 2	S	•	•	•	•	•	•	
		3 F				İ					1					ĺ												
	SWI3©	1 1		2								li								Software interrupt 3	s	•	•	•	•	•	•	
SYNC		3 F															1				11	. !	, ,					1
_		1 3	≥4	1						l										Synchronize to interrupt	•	•	•	•	•	•	•	•
TFR	R1. R2	1 F	6	2				ll					i				i			R1 → R2(2)	1.1			0	i			I.
TST	TSTA	4 D	2	1																Test A					,7	1	R	
	TSTB	5 D	2	1																Test B						:	R	
	TST	1			0 D	6	2	7 D	7	3				6 D	6 +	2 +				Test M					:	i	R	

(NOTES)

(1) This column gives a base cycle and byte count. To obtain total count, and the values obtained from the INDEXED ADDRESSING MODES table.

The 8 bit registers are: A, B, CC, DP
The 16 bit registers are: X, Y, U, S, D, PC
(2) EA is the effective address.
(3) The PSH and PUL instructions require 5 cycle plus 1 cycle for each byte pushed or pulled.
(5) 516) means: 5 cycles if branch not taken, 6 cycles if taken.
(6) SWI sets 1 and F bits. SWI2 and SWI3 do not affect I and F.
(7) Conditions Codes set as a direct result of the instruction.
(8) Special Case — Carry set if b7 is SET.
(8) Special Case — Carry set if b7 is SET.
(9) Condition Codes set as a direct result of the instruction if CC is specified, and not affected otherwise.

- Condition Codes set as a direct result of the instruction if CC is specified, and not affected otherwise.

LEGEND:

- Operation Code (Hexadecimal)
 Number of MPU Cycles
 Number of Program Bytes
 Arithmetic Plus Zero (byte) Overflow, 2's complement
- Carry from bit 7
 Test and set if true, cleared otherwise Arithmetic Minus Multiply Not Affected ZIIZ
 - CC Condition Code Register Complement of M Concatenation
 - Transfer Into Half-carry (from bit 3) Negative (sign bit) Logical or Logical and Logical Exclusive or

Table 10 Hexadecimal Values of Machine Codes

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#
_			_		30	LEAX	Indexed	4+	2+	60	NEG	Indexed	6+	2+
00	NEG	Direct	6	2	31	LEAY	4	4+	2+	61	•	†		
01	•	7			32	LEAS		4+	2+	62	•			
02			6	2	33	LEAU	Indexed	4+	2+	63	COM	1	6+	2+
03	COM	i	6	2	34	PSHS	Implied	5+	2	64	LSR		6+	2+
04	LSR	- 1	•	2	35	PULS	A	5+	2	65	•	į.		
05	•	- 1	_	2	36	PSHU	1	5+	2	66	ROR	1	6+	2+
06	ROR	1	6	2	37	PULU		5+	2	67	ASR		6+	2+
07	ASR	Į.	6	2	38	*	l.	-		68	ASL, LS	L	6+	2+
08	ASL, LSL		6		36 39	RTS	ļ	5	1	69	ROL	1	6+	2+
09	ROL	1	6	2	3 9	ABX	. ↓	3	1	6A	DEC		6+	2+
OA	DEC		6	2	3B	RTI	Implied	6, 15	1	6B	•			
OB	•		_	_	3E	CWAI	Immed	≥ 20	2	6C	INC	ŀ	6+	2+
OC.	INC		6	2		MUL	Implied	11	1	6D	TST	1	6+	2+
OD	TST	ì	6	2	3D	MUL.	mpnea	• • •	•	6E	JMP	•	3+	2+
OΕ	JMP	•	3	2	3E	SWI	Implied	19	1	6F	CLR	Indexed	6+	2+
OF	CLR	Direct	6	2	3F	2441	IIIpiieu		•					
					40	NEGA	Implied	2	1	70	NEG	Extended	7	3
10	∖ See	-	_	_		NEGA	A	-	-	71	•	4		
11	Next Page	-	-	-	41	•	T			72	•	ļ		
12	NOP	Implied	2	1	42	COMA		2	1	73	COM		7	3
13	SYNC	Implied	≥ 4	1	43		1	2	1	74	LSR	Ì	7	3
14	•				44	LSRA		-	•	75	•			
15	•				45			2	1	76	ROR		7	3
16	LBRA	Relative	5	3	46	RORA		2	i	77	ASR		7	3
17	LBSR	Relative	9	3	47	ASRA		2	i	78	ASL, LS	su İ	7	3
18	•				48	ASLA, LSLA	1	2	i	79	ROL	-	7	3
19	DAA	Implied	2	1	49	ROLA	ļ	2	i	7A	DEC	ì	7	3
1A	ORCC	Immed	3	2	4A	DECA		2	•	7B	•			
18	•	_			4B	•				7C	INC	1	7	3
1C	ANDCC	Immed	3	2	4C	INCA	i	2	1	70	TST	1	7	3
10	SEX	Implied	2	1	4D	TSTA	i i	2	•	7E	JMP	1	4	3
1E	EXG	1	8	2	4E	•		_		7E 7F	CLR	Extended	7	3
16	TER	Implied	6	2	4F	CLRA	Implied	2	1	/F	CLN	Extended	•	•
• • •								_		80	SUBA	Immed	2	2
20	BRA	Relative	3	2	50	NEGB	Implied	2	1	81	CMPA	A	2	2
21	BRN	4	3	2	51	•	Ť			82	SBCA		2	2
22	BHI	1	3	2	52	•	ļ	_			SUBD		4	3
23	BLS	Ì	3	2	53	COMB	ŀ	2	1	83		1	2	2
24	BHS, BCC		3	2	54	LSRB	1	2	1	84	ANDA		2	2
25	BLO, BCS	i i	3	2	55	•	ŀ			85	BITA	1	2	2
26	BNE	1	3	2	56	RORB	1	2	1	86	LDA	ļ	-	-
27	BEQ	i	3	2	57	ASRB	i	2	1	87		1	2	2
28	BVC	1	3	2	58	ASLB, LSLB		2	1	88	EORA	1	2	2
29 29	BVS		3	2	59	ROLB	İ	2	1	89	ADCA		2	2
29 2A		1	3	2	5A	DECB	1	2	1	8A	ORA	1	2	2
28			3	2	58	•	i			8B	ADDA		4	3
26	_		3	2	5C	INCB	- !	2	1	8C	CMPX	Immed		2
			3	2	5D	TSTB	1	2	1	8D	BSR	Relative	7	3
20 2E		1	3	2	5E	•	+			8E	LDX	Immed	3	3
_		Relative	3	2	5F	CLRB	Implied	2	1	8F	•			
2F	DLE	Lining	•	-	٥.									

LEGEND:

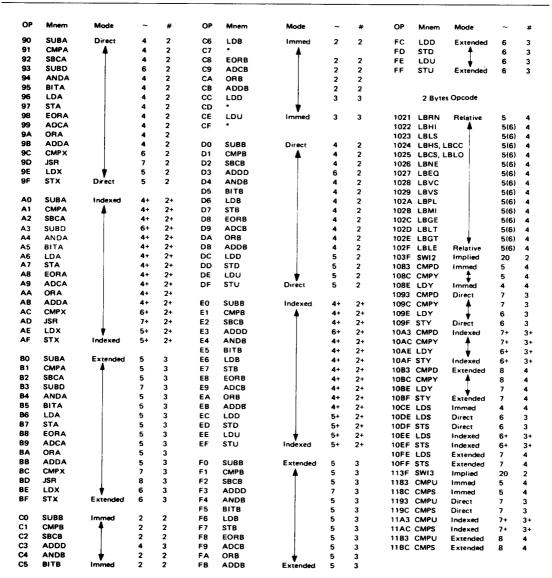
Number of MPU cycles (less possible push pull or indexed-mode cycles)

Number of program bytes

Denotes unused opcode

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(to be continued)



(NOTE): All unused opcodes are both undefined and illegal

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NOTE FOR USE

Execution Sequence of CLR Instruction

Example: CLR (Extended)

xampie: C	LK (Extende	:u)		
\$8000 \$A000	CLR FCB	\$A000 \$80		
Cycle #	Address	Data	R/\overline{W}	Description
1	8000	7F	1	Opcode Fetch
2	8001	A0	1	Operand Address, High Byte
3	8002	00	1	Operand Address, Low Byte
4	FFFF	*	1	VMA Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	VMA Cycle
7	A000	00	0	Store Fixed "00" into Specified Location

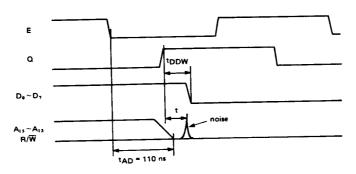
^{*} The data bus has the data at that particular address.

Cycle-by-cycle flow of CLR instruction (Direct, Extended, Indexed Addressing Mode) is shown below. In this sequence the content of the memory location specified by the operand is read before writing "00" into it. Note that status Flags, such as IRQ Flag, will be cleared by this extra data read operation when accessing the control/status register (sharing the same address between read and write) of peripheral devices.

The Noise of HD6309E at Bus Outputs Changing We shall notify you of the noise of the HD6309E.

The noise over 0.8V may appear on the output signals when data bus or address bus outputs change from "High" to "Low". Problems and countermeasure are shown as follows.

(1) The Noise at Data Bus Outputs Changing ("High-"Low") Problem: The noise over 0.8V may appear on A₁₅~A₁₃, R/W outputs change (worst case; \$FF-\$00) as shown in Figure 19.



Noise peak (worst case); about 1.5V

Test condition Ta = -20°C

V_{CC} = 5.5V

Number of data bus lines switching from "High" to "Low" = 8 (\$FF→\$00) data bus load capacitance = 130pF

Period of the noise occurrence (reference data)

t = 6~34ns (Ta = -20°C)

t = 8~43ns (Ta = 25°C)

t = 12~54ns (Ta = 75°C)

Figure 19 Noise at data bus output changing

Countermeasure: If the noise level can not be reduced by controlling data bus load capacitance or reducing

VCC in your application system, connect damping resistors (about $100\sim150\Omega$) to data bus to reduce the noise level as shown in Figure 20. Table 11 shows the relationship between damping resistors and electrical characteristics. Connecting damping resistors to data bus is effective to reduce the noise level as shown in Figure 21.



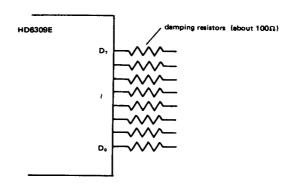
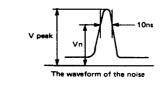


Figure 20 Connecting damping resistors to data bus

Table 11 The relationship between damping resistors and electrical characteristics

			R = 0Ω	R = 100 ~ 150Ω
HD63809E		$T_a = -20 \sim 0^{\circ} C$	20 ns	10 ns
(2MHz)	WHO [‡]	Ta = 0~75°C	30 ns	15 ns
HD63C09E	topw .		70 ns	80 ns
(3MHz)	t _{DHW}	Ta = -20~0°C	20 ns	10 ns
	4DHW	Ta = 0~75°C	30 ns	15 ns



Test condition

V_{CC} = 5.5V

Ta = -20° C

data bus load capacitance

= 130p F

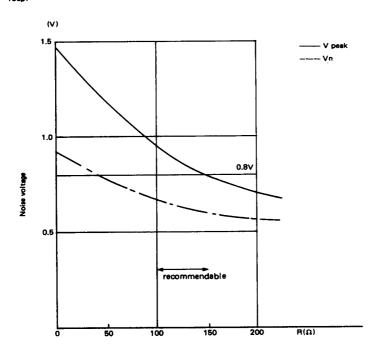


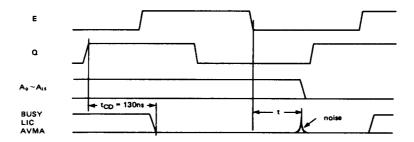
Figure 21 An example of the dependency of the noise voltage on damping resistors

2. The Noise at Address Bus Outputs Changing

("High" → "Low")

Problem: The noise over 0.8V may appear on BUSY, LIC,

AVMA outputs when address bus outputs change (worst case; \$FFFF-\$0000) as shown in Figure 22.



Noise peak (worst case); about 1.5V

Test condition Ta = -20°C

V_{CC} = 5.5V Number of address bus lines switching from "High" to "Low" = 16 (\$FFFF-\$0000) address bus load capacitance = 90pF

Period of the noise occurrence (reference data)

t = 25~65ns (Ta = -20°C) t = 30~74ns (Ta = 25°C)

t = 34~83ns (Ta = 75°C)

Figure 22 Noise at address bus output changing

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Countermeasure: To prevent the noise on BUSY, LIC, AVMA outputs from appearing, this signals must be latched at the negative edge of E or Q clock as

shown in Figure 23. An example of countermeasure circuit is shown in Figure 24.

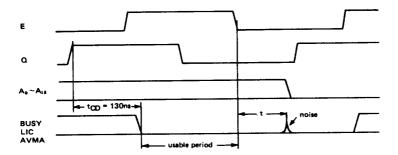


Figure 23 An example of countermeasure of the noise

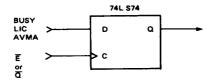


Figure 24 An example of countermeasure circuit